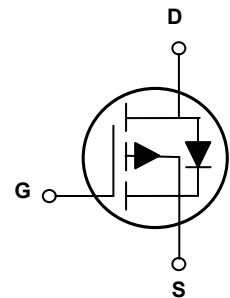
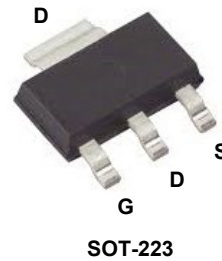


Main Product Characteristics

BV_{DSS}	-100V
$R_{DS(ON)}$	200m Ω
I_D	-2A



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFL1003 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^{\circ}\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous ($T_A=25^{\circ}\text{C}$)	I_D	-2	A
Drain Current-Continuous ($T_A=70^{\circ}\text{C}$)		-1.6	
Drain Current-Pulsed ¹	I_{DM}	-8	A
Single Pulse Avalanche Energy ²	E_{AS}	24	mJ
Single Pulse Avalanche Current ²	I_{AS}	22	A
Power Dissipation ($T_A=25^{\circ}\text{C}$)	P_D	1.78	W
Power Dissipation - Derate above 25°C		0.014	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	70	$^{\circ}\text{C}/\text{W}$
Operating Junction Temperature Range	T_J	-55 To +150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 To +150	$^{\circ}\text{C}$

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On / Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-100	-	-	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-100V, V_{GS}=0V, T_J=25^\circ\text{C}$	-	-	-1	μA
		$V_{DS}=-80V, V_{GS}=0V, T_J=125^\circ\text{C}$	-	-	-10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-2A$	-	165	200	m Ω
		$V_{GS}=-4.5V, I_D=-1.5A$	-	180	230	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.2	-1.6	-2.2	V
Forward Transconductance	g_{fs}	$V_{DS}=-10V, I_D=-1.5A$	-	6.5	-	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{3,4}	Q_g	$V_{DS}=-50V, I_D=-1A$ $V_{GS}=-10V$	-	20	30	nC
Gate-Source Charge ^{3,4}	Q_{gs}		-	2.4	5	
Gate-Drain Charge ^{3,4}	Q_{gd}		-	3.3	7	
Turn-On Delay Time ^{3,4}	$t_{d(on)}$	$V_{DD}=-50V, R_G=6\Omega$ $V_{GS}=-10V, I_D=-1A$	-	18	27	nS
Rise Time ^{3,4}	t_r		-	8	12	
Turn-Off Delay Time ^{3,4}	$t_{d(off)}$		-	100	150	
Fall Time ^{3,4}	t_f		-	30	45	
Input Capacitance	C_{iss}	$V_{DS}=-50V, V_{GS}=0V,$ $F=1\text{MHz}$	-	1280	2000	pF
Output Capacitance	C_{oss}		-	55	100	
Reverse Transfer Capacitance	C_{rss}		-	30	60	
Gate Resistance	R_g	$V_{GS}=0V, V_{DS}=0V,$ $F=1\text{MHz}$	-	16	-	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0V,$ Force Current	-	-	-2	A
Pulsed Source Current	I_{SM}		-	-	-4	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-1A,$ $T_J=25^\circ\text{C}$	-	-	-1	V
Reverse Recovery Time	t_{rr}	$V_R=-100V, I_S=-1A$ $di/dt=100A/\mu s,$ $T_J=25^\circ\text{C}$	-	35	-	nS
Reverse Recovery Charge	Q_{rr}		-	30	-	nC

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=22A,$ starting $T_J=25^\circ\text{C}$.
3. Pulse test: pulse width $\leq 300\mu s,$ duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

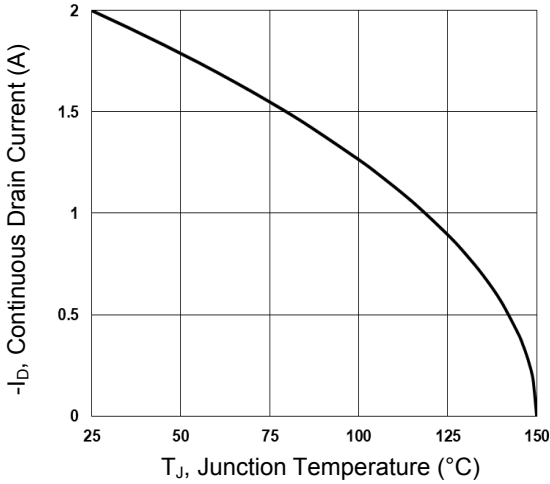


Figure 1. Continuous Drain Current vs. T_J

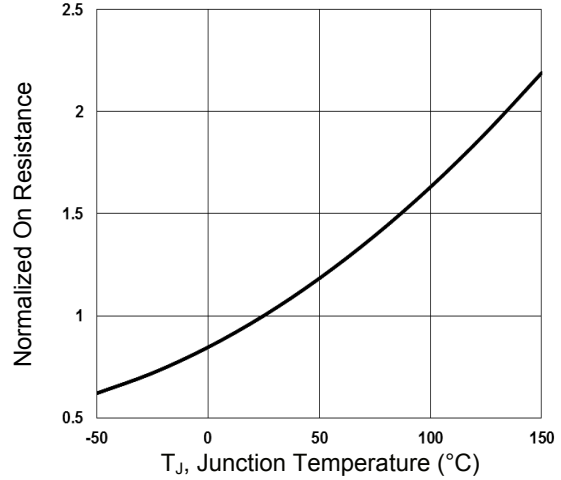


Figure 2. Normalized $R_{DS(on)}$ vs. T_J

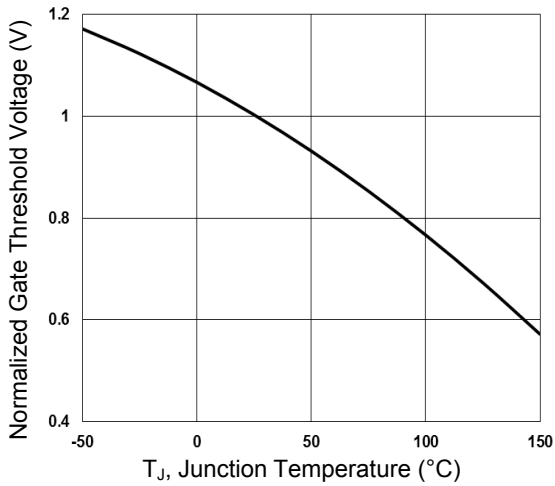


Figure 3. Normalized V_{th} vs. T_J

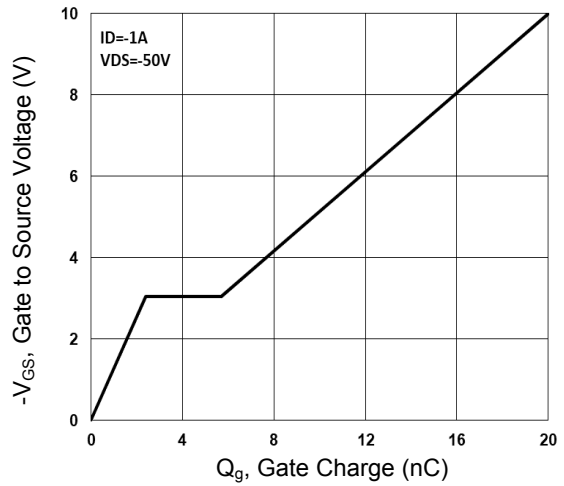


Figure 4. Gate Charge Characteristics

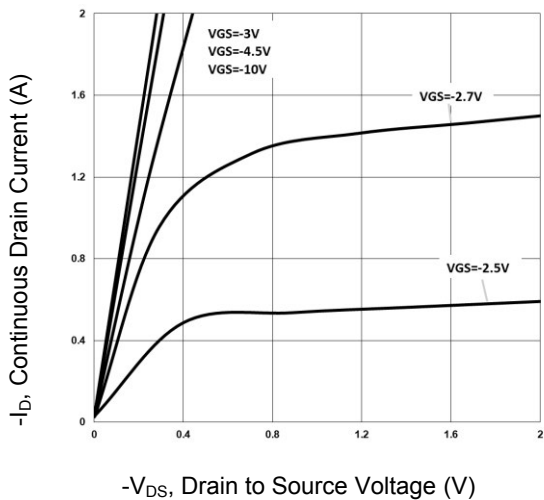


Figure 5. Typical Output Characteristics

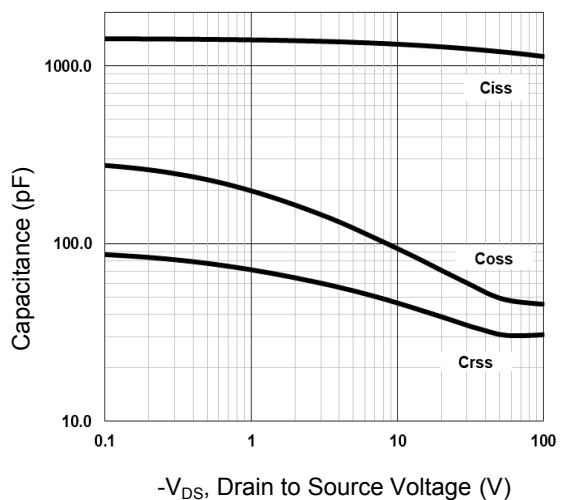


Figure 6. Capacitance Characteristics

Typical Electrical and Thermal Characteristic Curves

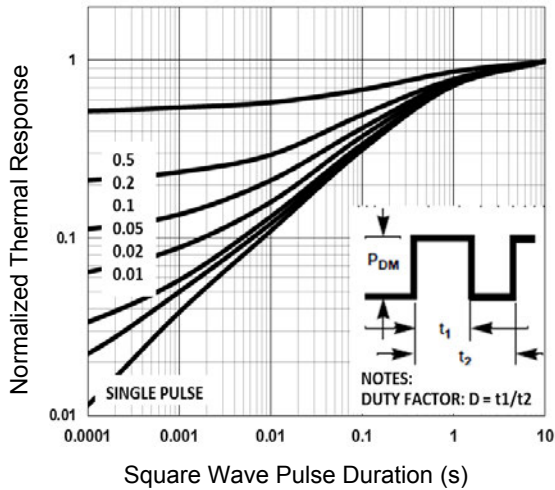


Figure 7. Normalized Transient Impedance

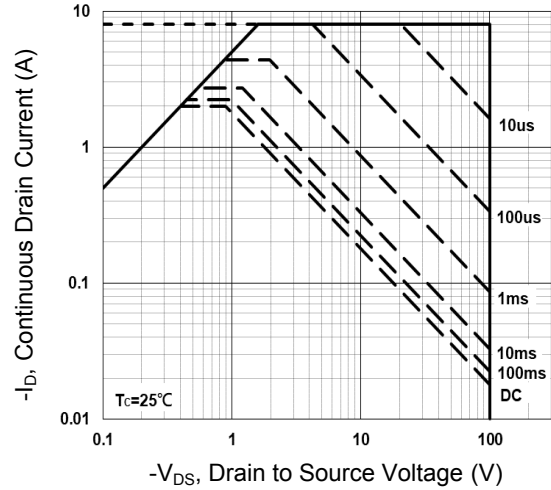


Figure 8. Maximum Safe Operation Area

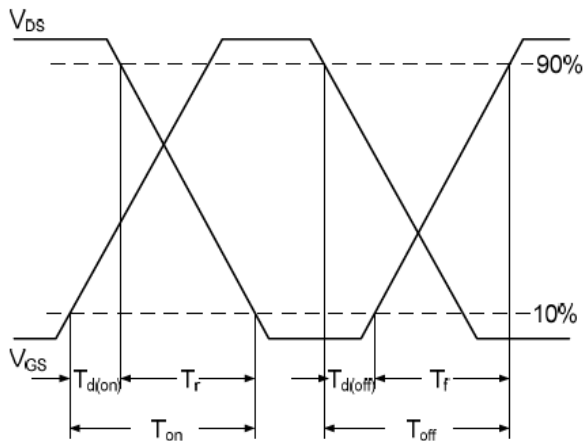


Figure 9. Switching Time Waveform

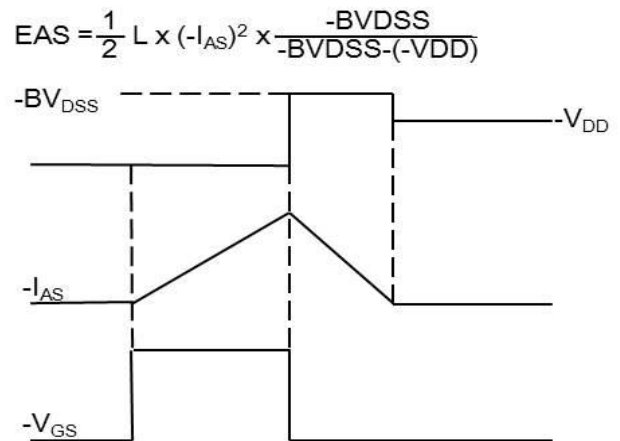
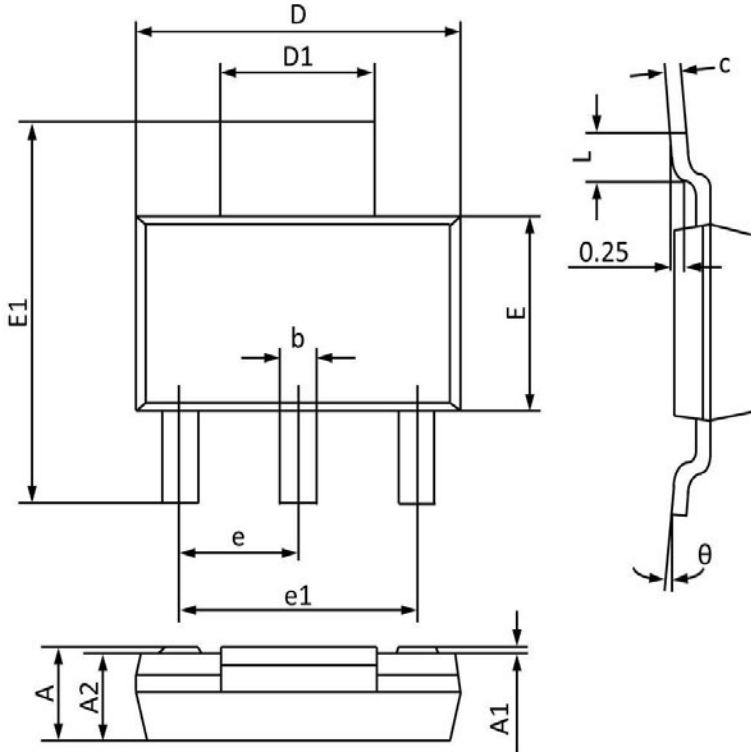


Figure 10. EAS Waveform

Package Outline Dimensions SOT-223



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	1.500	1.800	0.060	0.071
A1	0.000	0.120	0.000	0.005
A2	1.450	1.750	0.057	0.069
b	0.600	0.820	0.024	0.032
c	0.200	0.350	0.008	0.014
D	6.200	6.700	0.244	0.264
D1	2.900	3.100	0.114	0.122
E	3.300	3.700	0.130	0.146
E1	6.700	7.300	0.264	0.287
e	2.30 BSC		0.091 BSC	
e1	4.400	4.700	0.173	0.185
L	0.900	1.150	0.035	0.045
θ	0°	10°	0°	10°